

APPLICATIONS



- Battery-powered devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

FEATURES

- Size 6.6mmx6.4mmx5.8mm
- Low DCR
- Low AC Losses
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS

Parameter			Value	Unit
Inductance ⁽¹⁾	L	$\pm 20\%$	10	μ H
Resistance	R_{DC}	typ	24	m Ω
Resistance _{MAX}	$R_{DC\ MAX}$	max	29.4	m Ω
Rated Current ⁽²⁾	I_R	typ	6.9	A
Saturation Current _{25°C} ⁽³⁾	$I_{SAT\ 25°C}$	typ	6.6	A
Saturation Current _{100°C} ⁽⁴⁾	$I_{SAT\ 100°C}$	typ	6.6	A
Resonance Frequency	f_r	typ	10	MHz

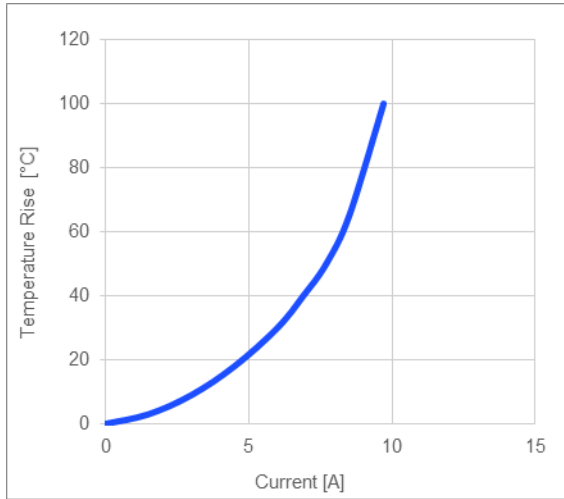
GENERAL SPECIFICATIONS

⁽¹⁾ Inductance	Measured at 100kHz, 100mA
⁽²⁾ Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
⁽³⁾ Saturation Current _{25°C}	Saturation current will cause L to drop from 30% at 25°C ambient temperature
⁽⁴⁾ Saturation Current _{100°C}	Saturation current will cause L to drop from 30% at 100°C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise) Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

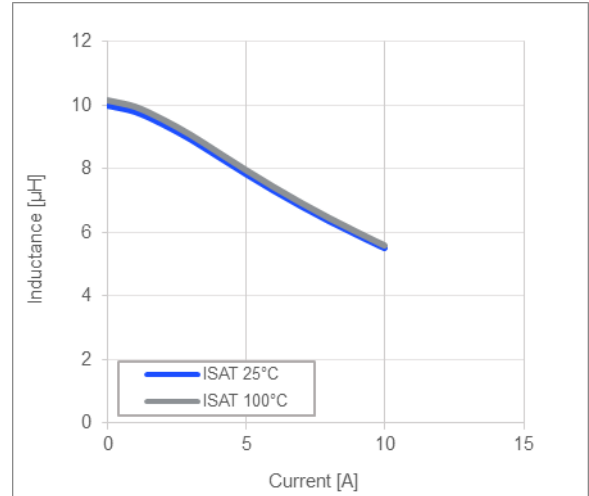
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TYPICAL PERFORMANCE CURVES

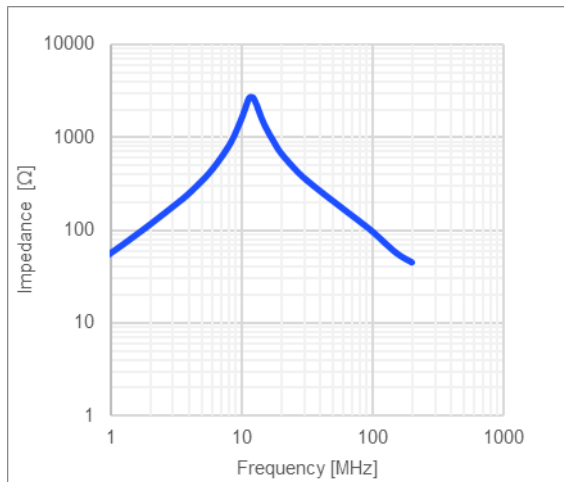
Temperature Rise vs. Current



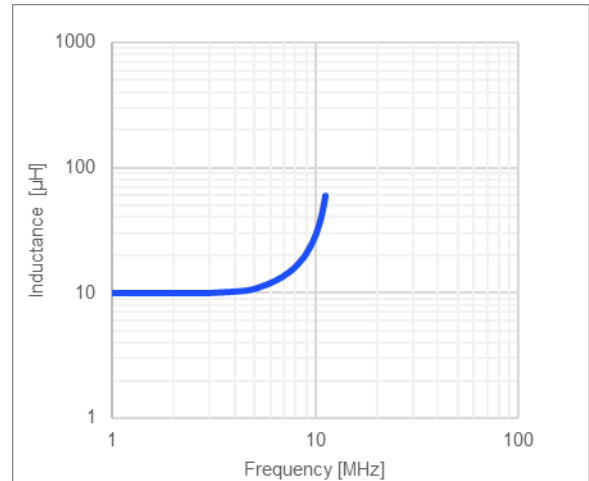
Inductance vs. Current



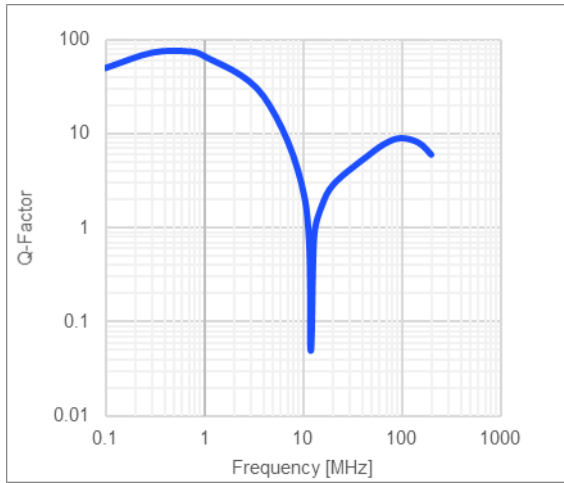
Impedance vs. Frequency



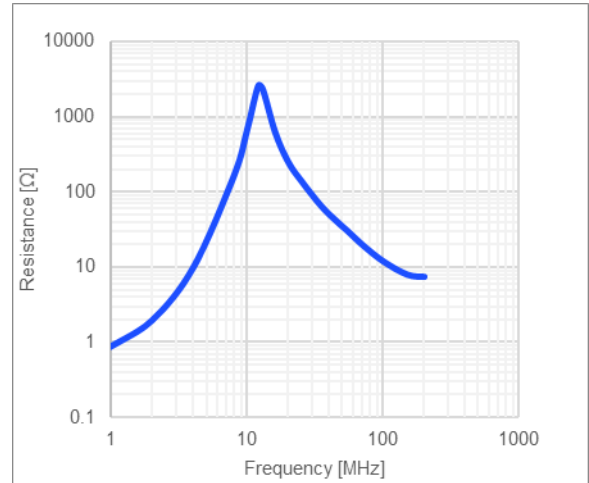
Inductance vs. Frequency



Quality Factor vs. Frequency



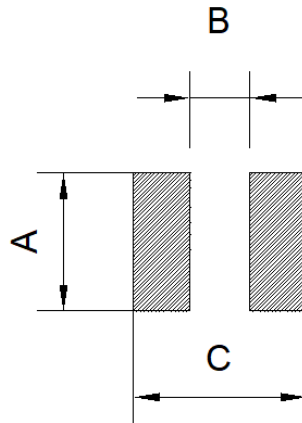
AC Resistance vs. Frequency



LAND PATTERN

Dimensions	
A	5.60 ref.
B	2.50 ref.
C	5.60 ref.

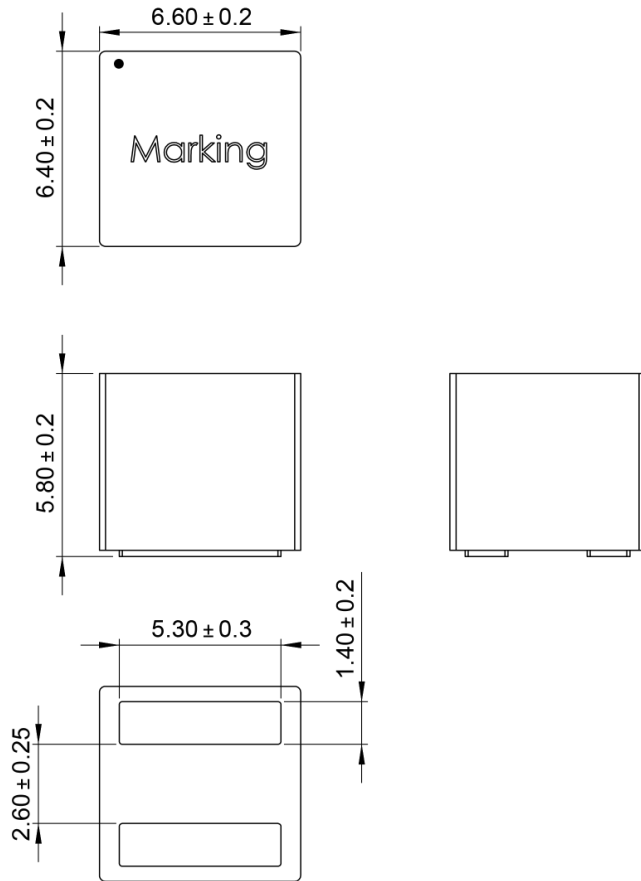
(unit in mm)



PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)



TOP MARKING

Marking	
Start of Winding	· (dot)
Inductance Code	100
MPS Code	MPS

ORDERING INFORMATION

Part Number	$L^{(1)}$	R_{DC}	$I_R^{(2)}$	$I_{SAT\ 25^\circ C}^{(3)}$	$I_{SAT\ 100^\circ C}^{(4)}$
	typ (μ H)	typ (m Ω)	typ (A)	typ (A)	typ (A)
MPL-AL6060-4R7	4.7	12	10.0	9	9
MPL-AL6060-5R6	5.6	13	9.4	8.6	8.6
MPL-AL6060-6R8	6.8	16	8.5	8	8
MPL-AL6060-8R2	8.2	19	8.0	7	7
MPL-AL6060-100	10	24	6.9	6.6	6.6
MPL-AL6060-150	15	35	5.8	5.5	5.5

GENERAL SPECIFICATIONS
(1) Inductance

Measured at 100kHz, 100mA

(2) Rated Current

Rated current will cause the coil temperature rise ΔT of 40K
 I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.

(3) Saturation Current $_{25^\circ C}$

 Saturation current will cause L to drop from 30% at 25 $^\circ$ C ambient temperature

(4) Saturation Current $_{100^\circ C}$

 Saturation current will cause L to drop from 30% at 100 $^\circ$ C ambient temperature

Temperature Test Condition

 Electrical specifications measured at 25 $^\circ$ C, 35% RH if not given differently

Operating Condition

Operating temperature: -40 $^\circ$ C to +155 $^\circ$ C (including temp rise)
 Should not exceed +155 $^\circ$ C under worst-case operation conditions

Storage Condition

Tape and Reel packaging: -10 $^\circ$ C to +40 $^\circ$ C
 Humidity: <50% RH

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